



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Donald C. Foster and Kelly R. McKendrick, Sr.
Assignee: Amkor Technology, Inc.
Title: Leadframe Having Fine Pitch Bond Fingers Formed Using Laser Cutting Method
Serial No.: 09/895,501 Filing Date: June 29, 2001
Docket No.: M-11315 US

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San Jose, California
October 8, 2001

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR § 1.97(b)

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the documents listed on the accompanying form PTO-1449 are called to the attention of the Examiner for the above patent application. Copies of these documents are enclosed.

Citation of these documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made, other than as described above; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on October 8, 2001

[Signature]
Attorney for Applicants

10-8-01
Date of Signature

Respectfully submitted,

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U.S. Department of Commerce, Patent and Trademark Office

Atty Docket No.

Serial No.

M-11315 US

09/895,501

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Applicants: Donald Craig Foster and

(Use several sheets if necessary)

Kelly Robbins McKendrick, Sr.

Filing Date: 6/29/01

Group

U.S. Patent Documents

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	5,521,429	05/28/96	Aono et al.	257	676	
	AB	5,977,630	11/02/99	Woodworth et al.	257	712	
	AC	6,025,640	02/15/00	Yagi et al.	257	666	
	AD	6,130,115	10/10/00	Okumura et al.	438	124	
	AE	6,143,981	11/07/00	Glenn	174	52.4	
	AF	6,198,171 B1	03/06/01	Huang et al.	257	787	
	AH	6,225,146 B1	05/01/01	Yamaguchi et al.	438	123	
	AG	6,229,200 B1	05/08/01	McLellan et al.	257	666	
	AI	6,242,281 B1	06/05/01	McLellan et al.	438	106	
	AJ	6,281,568 B1	08/28/01	Glenn et al.	257	684	

Foreign Patent Documents

							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
	AK	59-227143	12/20/84	Japan			X	
	AL	60-195957	10/04/85	Japan			X	
	AM	DE19734794A1	07/16/98	Germany				X
	AN	EP0794572A2	10/09/97	Europe			X	
	AO	7-312405	11/28/95	Japan			X	
	AP	8-125066	05/17/96	Japan			X	
	AQ	8-306853	11/22/96	Japan			X	
	AR	9-8205	01/10/97	Japan			X	
	AS	9-8206	01/10/97	Japan			X	
	AT	9-8207	01/10/97	Japan			X	
	AU	9-92775	04/04/97	Japan			X	

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

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+Examiner

Date Considered

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.